

L Number	Hits	Search Text	DB	Time stamp
1	2851	polishing ADJ pad	USPAT	2002/09/06 18:27
2	1781	(polishing ADJ pad) and (chemical ADJ mechanical ADJ polishing)	USPAT	2002/09/06 18:28
3	1391	((polishing ADJ pad) and (chemical ADJ mechanical ADJ polishing)); and substrate	USPAT	2002/09/06 18:28
4	389	((polishing ADJ pad) and (chemical ADJ mechanical ADJ polishing)) and substrate) and groove\$1	USPAT	2002/09/06 18:29
5	43	((polishing ADJ pad) and (chemical ADJ mechanical ADJ polishing)) and substrate) and groove\$1) and pitch	USPAT	2002/09/06 18:29
6	193	((polishing ADJ pad) and (chemical ADJ mechanical ADJ polishing)) and substrate) and groove\$1) and depth	USPAT	2002/09/06 18:30
7	130	((polishing ADJ pad) and (chemical ADJ mechanical ADJ polishing)) and substrate) and groove\$1) and depth) and width	USPAT	2002/09/06 18:30
8	17	((polishing ADJ pad) and (chemical ADJ mechanical ADJ polishing)) and substrate) and groove\$1) and depth) and width) and pitch	USPAT	2002/09/06 18:30